# **Schottky Barrier Diode**

Schottky barrier diodes are designed primarily for high–efficiency UHF and VHF detector applications. Readily available to many other fast switching RF and digital applications.

### Features

- Very Low Capacitance Less than 1.0 pF @ 0 V
- Low Noise Figure 6.0 dB Typ @ 1.0 GHz
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



Rating	Symbol	Value	Unit
Reverse Voltage	V <sub>R</sub>	7.0	Vdc

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	
Total Device Dissipation FR–5 Board, (Note 1) @T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	200 1.57	mW mW/°C	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	635	°C/W	
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 Minimum Pad

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μA)	V <sub>(BR)R</sub>	7.0	10	-	V
Diode Capacitance $(V_R = 0, f = 1.0 \text{ MHZ}), (Note 2)^*$	CT	-	0.88	1.0	pF
Reverse Leakage (V <sub>R</sub> = 3.0 V)	I <sub>R</sub>	-	20	250	nAdc
Noise Figure (f = 1.0 GHz), (Note 3)*	NF	_	6.0	_	dB
Forward Voltage (I <sub>F</sub> = 10 mA)	V <sub>F</sub>	-	0.5	0.6	Vdc

\*Notes on Next Page



# **ON Semiconductor®**

http://onsemi.com

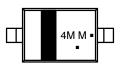
# 1.0 pF SCHOTTKY BARRIER DIODE





SOD-323 CASE 477 STYLE 1

## MARKING DIAGRAM



4M = Device Code M = Date Code\*

### = Pb–Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMDL101T1G	SOD-323 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MMDL101T1G

### **TYPICAL CHARACTERISTICS**

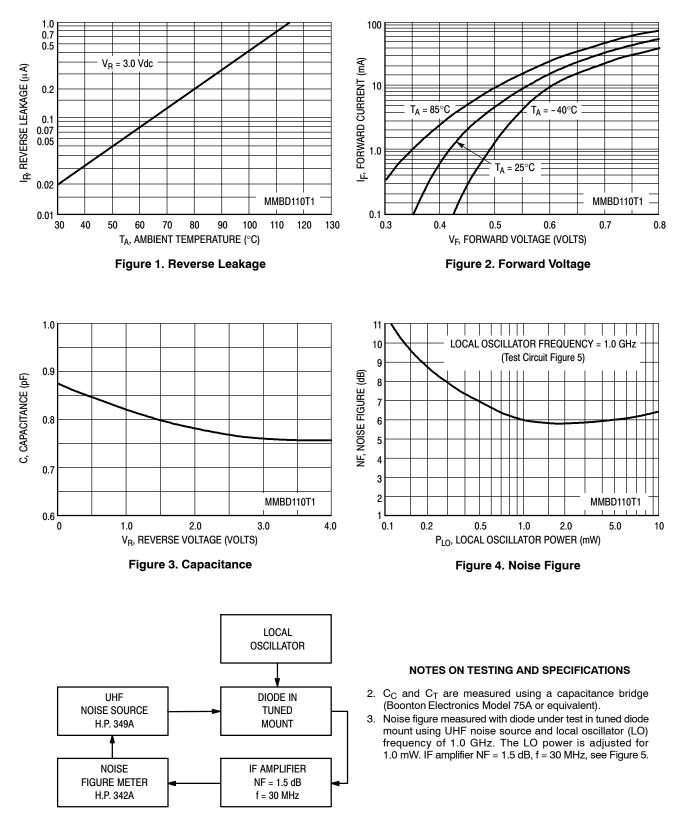
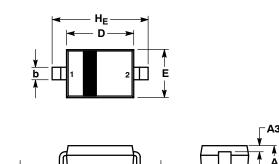


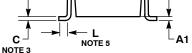
Figure 5. Noise Figure Test Circuit

### MMDL101T1G

#### PACKAGE DIMENSIONS

SOD-323 CASE 477-02 ISSUE H





NOTES 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

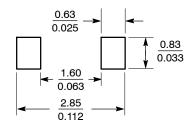
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING. DIMENSIONS A AND B DO NOT INCLUDE MOLD З.
- 4.
- FLASH, PROTRUSIONS OR GATE BURRS. 5

DIMENSION LIS MEASURED I NOM END OF HADIC							
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.031	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A3	0.15 REF			0.006 REF			
b	0.25	0.32	0.4	0.010	0.012	0.016	
С	0.089	0.12	0.177	0.003	0.005	0.007	
D	1.60	1.70	1.80	0.062	0.066	0.070	
Е	1.15 1.25 1.35		0.045	0.049	0.053		
L	0.08			0.003			
He	2.30	2 50	2 70	0 090	0.098	0 105	

HE 2.70 0.090 0.098 0.105 STYLE 1:

PIN 1. CATHODE (POLARITY BAND) 2. ANODE

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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